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OFFICIAL**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Doane

Art Unit: 2625

Serial No.: 09/746,102

Examiner: Desire, Gregory M.

Filed: 21 December 2000

Docket No. TI-23064

For: METHODS FOR MEASURING DMD LOW SPATIAL UNIFORMITY

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NAME OF INVENTOR(S): Doane		RECEIPT DATE & SERIAL NO.: Application No.: 09/746,102 Filing Date: 12/21/2000	
TITLE OF INVENTION: Methods for Measuring DMD Low Spatial Uniformity			
TI FILE NO.: TI-23064	DEPOSIT ACCT. NO.: 20-0668		
FAXED: 03/05/2004 DUE: 1/7/2004 ATTY/SECY: CAB:as			

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